

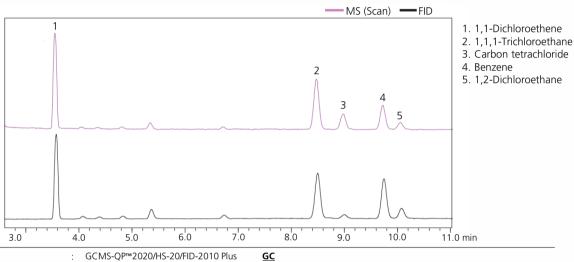
CoreFocus Report

**GCMS** FID HS **SH Series** 

### SH-I-624Sil MS

### **Analysis of Residual Solvents in Pharmaceuticals**

**Keywords: Headspace** 



Model

Splitting System

<u>HS</u>

Mode Loop (volume 1 mL) 80 °C Oven temp. 90°C Sample line temp.

Transfer line temp. 105 ℃ Gas pressure 76.4 kPa for vial pressurization Vial equilibrating time 45 min Vial pressurizing time 2.0 min Pressure equilibrating time 0.1 min Load time 0.5 min Load equilibrating time 0.1 min

Injection time 0.5 min Needle flushing time 15.0 min 20 kPa APC pressure

SH-I-624Sil MS (30 m x 0.32 mm I.D., 1.8  $\mu$ m) Column

P/N: 227-36077-01 Split (Split ratio 1:5)

Constant pressure (89.4 kPa) Control mode Carrier gas

40 °C (20 min) - 10 °C/min - 240 °C (20 min) Oven temp.

Restrictor (FID) 1.1 m x 0.25 mm Restrictor (MS) 1.5 m x 0.20 mm 20 kPa

APC pressure FID

Injection mode

250 °C Temp. 30 mL/min (He) Make-up flow rate Hydrogen flow rate 40 mL/min Air flow rate 400 mL/min

MS

lon source temp. 200 °C Interface temp. 250°C m/z 29 to 250 SCAN range

Event time 0.3 s

Source : Application News M272 (JP, ENG)

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